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CONFIRMATION NO. 2807

<b>SERIAL NUMBER</b> 10/786,426	<b>FILING OR 371(c) DATE</b> 02/25/2004 <b>RULE</b>	<b>CLASS</b> 438	<b>GROUP ART UNIT</b> 2812	<b>ATTORNEY DOCKET NO.</b> Analog.6830CON
<b>APPLICANTS</b> Colin Stephen Gormley, Belfast, IRELAND; Stephen Alan Brown, Newtownards, IRELAND; Scott Carlton Blackstone, Alton, NH;				
<b>** CONTINUING DATA *****</b> <i>TN</i> This application is a CON of 10/194,392 07/12/2002 PAT 6,723,579				
<b>** FOREIGN APPLICATIONS *****</b> <i>TN</i> <i>none</i>				
<b>IF REQUIRED, FOREIGN FILING LICENSE GRANTED</b> <b>** 05/22/2004</b>				
Foreign Priority claimed <input type="checkbox"/> yes <input checked="" type="checkbox"/> no 35 USC 119 (a-d) conditions <input type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after met Verified and <i>TN</i> Acknowledged <i>TN</i> Examiner's Signature Initials		<b>STATE OR COUNTRY</b> IRELAND	<b>SHEETS DRAWING</b> 9	<b>TOTAL CLAIMS</b> 24
				<b>INDEPENDENT CLAIMS</b> 1
<b>ADDRESS</b> Gauthier & Connors LLP Suite 3300 225 Franklin Street Boston, MA 02110				
<b>TITLE</b> Semiconductor wafer comprising micro-machined components and a method for fabricating the semiconductor wafer				
<b>FILING FEE RECEIVED</b> 842	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:		<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees ( Filing ) <input type="checkbox"/> 1.17 Fees ( Processing Ext. of time ) <input type="checkbox"/> 1.18 Fees ( Issue ) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit	

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